

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Kwon, Heung-Kyu; Cho, Min-Kyo

Assignee: Samsung Electronics Co., Limited

Chris C. Chu

Title: Semiconductor Chip Package and Method of Fabricating the Same

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2815

Group Art Unit:

Docket No.: AB-881 US

San Francisco, California August 27, 2002

COMMISSIONER FOR PATENTS Washington, D. C. 20231

## **RESPONSE TO OFFICE ACTION**

Dear Sir:

Examiner:

This paper is responsive to the Office Action that was mailed from the U.S. Patent and Trademark Office on February 28, 2002, which has a period of time for reply that ended May 28, 2002. The time for responding has been extended to August 28, 2002 by the enclosed Petition and extension of time fee.

Applicant respectfully requests reconsideration of the Application in view of the following amendments and remarks.

## **AMENDMENTS**

## IN THE CLAIMS

This submission cancels Claims 1 and 16 and amends Claims 2, 3, 5-8, 10, 11, 13, 14, 17-20. The following is a clean version of the Claims. In accordance with 37 C.F.R. §1.121(c)(1)(ii), Attachment A provides a marked up version of amended Claims 2-8, 10, 11,

Serial No. 09/464,322